


PRODUCT / PROCESS CHANGE INFORMATION

1. PCI basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCI No.	ADG/18/10708	
1.3 Title of PCI	TO-3PF Change Tube Printing - Subcon in Korea	
1.4 Product Category	Power MOSFET, IGBT, Rectifier	
1.5 Issue date	2018-02-08	

2. PCI Team

2.1 Contact supplier	
2.1.1 Name	MARSHALL DAVE
2.1.2 Phone	
2.1.3 Email	dave.marshall@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Maurizio GIUDICE,Franck DUCLOS
2.1.2 Marketing Manager	Philippe LEGER,Anna MOTTESE
2.1.3 Quality Manager	Vincenzo MILITANO,Jean-Paul REBRASSE

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Materials	New Indirect material part number (same supplier or different supplier): Boxes, trays, carriers, back grinding tape, wafer mounting tape, capillary, mold tape, etc..	Subcon in Korea

4. Description of change

	Old	New
4.1 Description	Recycle symbol, antistatic and PVC text are printed on the side of tube.	Recycle symbol, antistatic and PVC text are printed on the Top side of tube.
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No impact	

5. Reason / motivation for change

5.1 Motivation	PCN from Subcontractor
5.2 Customer Benefit	LOGISTICS IMPROVEMENT

6. Marking of parts / traceability of change

6.1 Description	by Q.A. number from week 09/2018
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7. Timing / schedule

7.1 Date of qualification results	2018-01-30
7.2 Intended start of delivery	2018-03-05
7.3 Qualification sample available?	Not Applicable

8. Qualification / Validation

8.1 Description			
8.2 Qualification report and qualification results	In progress	Issue Date	

9. Attachments (additional documentations)

10708 Public product.pdf
10708 TO-3PF Change Tube Printing - Subcon in Korea.pdf

10. Affected parts

10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	BU941ZPFI	
	MD2310FX	
	STTH60AC06CPF	

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